

07-12-2002

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RECORDATION FORM COVER SHEET

PATENTS ONLY



07-08-02

OFFICE OF THE PATENT RECORDATION

102153246

TO THE HONORABLE DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE. PLEASE RECORD THE ATTACHED ORIGINAL DOCUMENTS OR COPY THEREOF.

1. Name of conveying party(ies):

KUO, Frank

Additional name(s) of conveying party(ies) attached?

☐ Yes☒ No

2. Name and address of receiving party(ies):

Name: Siliconix Taiwan Ltd.

Address: No. 3-3, East 2nd Street, Nan-Tzu Export Processing Zone, Kaohsiung City, Taiwan, R.O.C.

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: June 10, 2002

Name and address of receiving party(ies):

Name:

Address:

Additional name(s) & address(es) attached?

☐ Yes☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s) - {Patent Application Numbers}

B. Patent No.(s)

Title: ENCAPSULATION METHOD AND LEADFRAME OF LEADLESS SEMICONDUCTOR PACKAGE

Additional numbers attached?



Yes



No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Norman R. Klivans

Internal Address: SKJERVEN MORRILL LLP

Street Address: 25 METRO DRIVE, SUITE 700

City: SAN JOSE State: CA Zip: 95110

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00



Authorized to be charged to Deposit Account 19-2386



Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Norman R. Klivans 33.003
Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and documents: 2

INSTRUCTIONS

ASSIGNMENT OF U.S. RIGHTS TO CORPORATION

WHEREAS,

Inventor(s) Name, Address, Citizenship
 1. Frank Kuo residing at 8F, No. 30, Lin-Chuan St., Lin-Ya Dist., Kaohsiung City, Taiwan, R.O.C.
 and a citizen of Taiwan, R.O.C.
 2. _____ residing at _____
 and a citizen of _____
 3. _____ residing at _____
 and a citizen of _____
 Date Patent Declaration Signed and Title
 (herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on Taiwan, R.O.C. for this invention, which application is entitled ENCAPSULATION METHOD AND LEADFRAME OF LEADLESS SEMICONDUCTOR PACKAGE and which has been given Serial Number 10/113,526 and the filing date of 28 March 2002
 Name of Corporation
 AND WHEREAS Siliconix Taiwan Ltd. (herein called "ASSIGNEE"), a corporation organized under the laws of Taiwan, R.O.C., and having an office and place of business at No.3-3, East 2nd Street, Nan-Tzu Export Processing Zone, Kaohsiung City, Taiwan, R.O.C.
 State or Country of Incorporation and Address
 wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for the United States in and to the invention disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by THE UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Each Inventor Must Sign and Date
 Signature Frank Kuo Date June 10, 2002
 Note: No Legalization or Other Witness Required
 Signature _____ Date _____
 Signature _____ Date _____

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